

## Is Now Part of



## ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



July 2001 Revised July 2001

## **FIN1031**

## 3.3V LVDS 4-Bit High Speed Differential Driver

### **General Description**

This quad driver is designed for high speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver translates LVTTL signal levels to LVDS levels with a typical differential output swing of 350mV which provides low EMI at ultra low power dissipation even at high frequencies. This device is ideal for high speed transfer of clock and data.

The FIN1031 can be paired with its companion receiver, the FIN1032, or any other Fairchild LVDS receiver.

#### **Features**

- Greater than 400Mbs data rate
- 3.3V power supply operation
- 0.4ns maximum differential pulse skew
- 2.0ns maximum propagation delay
- Low power dissipation
- Power OFF protection
- Meets or exceeds the TIA/EIA-644 LVDS standard
- Pin compatible with equivalent RS-422 and LVPECL devices
- 16-Lead SOIC and TSSOP packages save space

## **Ordering Code:**

Order Number	Package Number	Package Description
FIN1031M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
FIN1031MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

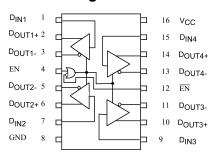
#### **Function Table**

Inputs			Outputs		
EN	EN	D <sub>IN</sub>	D <sub>OUT+</sub>	D <sub>OUT</sub>	
Н	Х	Н	Н	L	
Н	Х	L	L	Н	
Н	X	OPEN	L	Н	
Х	L	Н	Н	L	
Х	L	L	L	Н	
X	L	OPEN	L	Н	
L	Н	Х	Z	Z	

H = HIGH Logic Level X = Don't Care

L = LOW Logic Level Z = High Impedance

## **Connection Diagram**



### **Pin Descriptions**

Pin Name	Description
D <sub>IN1</sub> , D <sub>IN2</sub> , D <sub>IN3</sub> , D <sub>IN4</sub>	LVTTL Data Inputs
$D_{OUT1+},D_{OUT2+},D_{OUT3+},D_{OUT4+}$	Non-Inverting Driver Outputs
$D_{OUT1-}, D_{OUT2-}, D_{OUT3-}, D_{OUT4-}$	Inverting Driver Outputs
EN	Driver Enable Pin
EN	Inverting Driver Enable Pin
V <sub>CC</sub>	Power Supply
GND	Ground

## **Absolute Maximum Ratings**(Note 1)

## Recommended Operating Conditions

Supply Voltage ( $V_{CC}$ ) -0.5V to +4.6V

DC Input Voltage (V<sub>IN</sub>)

DC Output Voltage (V<sub>OUT</sub>)

Lead Temperature (T<sub>L</sub>)

(Soldering, 10 seconds)  $260^{\circ}$ C ESD (Human Body Model)  $\geq 8000$ V ESD (Machine Model)  $\geq 600$ V

Note 1: The "Absolute Maximum Ratings": are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature and output/input loading variables. Fairchild does not recommend operation of circuits outside databook specification.

#### **DC Electrical Characteristics**

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 2)	Max	Units
V <sub>OD</sub>	Output Differential Voltage		250	350	450	mV
$\Delta V_{OD}$	V <sub>OD</sub> Magnitude Change from Differential LOW-to-HIGH	$R_L = 100\Omega$ , Driver Enabled,			25	mV
Vos	Offset Voltage	See Figure 1	1.125	1.25	1.375	V
ΔV <sub>OS</sub>	Offset Magnitude Change from Differential LOW-to-HIGH	]			25	mV
I <sub>OFF</sub>	Power Off Output Current	V <sub>CC</sub> = 0V, V <sub>OUT</sub> = 0V or 3.6V			±20	μΑ
Ios	Short Circuit Output Current	V <sub>OUT</sub> = 0V, Driver Enabled			-6	mA
		V <sub>OD</sub> = 0V, Driver Enabled			±6	mA
V <sub>IH</sub>	Input HIGH Voltage		2.0		V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage		GND		0.8	V
I <sub>IN</sub>	Input Current	$V_{IN} = 0V \text{ or } V_{CC}$			±20	μΑ
I <sub>OZ</sub>	Disabled Output Leakage Current	$EN = 0.8V, \overline{EN} = 2.0V$ $V_{OUT} = 0V \text{ or } 4.7V$			±20	μА
I <sub>I(OFF)</sub>	Power-OFF Input Current	V <sub>CC</sub> = 0V, V <sub>IN</sub> = 0V or 3.6V			±20	μΑ
V <sub>IK</sub>	Input Clamp Voltage	I <sub>IK</sub> = -18 mA	-1.5			V
I <sub>CC</sub>	Power Supply Current	No Load, V <sub>IN</sub> = 0V or V <sub>CC</sub> , Driver Enabled		3.2	5	
		$R_L = 100 \Omega$ , Driver Disabled		3.2	5	mA
		$R_L = 100 \Omega$ , $V_{IN} = 0V$ or $V_{CC}$ , Driver Enabled		17.9	25	
C <sub>IN</sub>	Input Capacitance			7		pF
C <sub>OUT</sub>	Output Capacitance			4		pF

Note 2: All typical values are at  $T_A = 25^{\circ}C$  and with  $V_{CC} = 3.3V$ .

### **AC Electrical Characteristics**

Over supply voltage and operating temperature ranges, unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ (Note 3)	Max	Units
t <sub>PLHD</sub>	Differential Propagation Delay LOW-to-HIGH		0.8	1.4	2.0	ns
t <sub>PHLD</sub>	Differential Propagation Delay HIGH-to-LOW		0.8	1.4	2.0	ns
t <sub>TLHD</sub>	Differential Output Rise Time (20% to 80%)	$R_L = 100 \Omega$ , $C_L = 10 pF$ ,	0.6	0.85	1.2	ns
t <sub>THLD</sub>	Differential Output Fall Time (80% to 20%)	See Figure 2 and Figure 3 (Note 7)	0.6	0.85	1.2	ns
t <sub>SK(P)</sub>	Pulse Skew  t <sub>PLH</sub> - t <sub>PHL</sub>				0.4	ns
t <sub>SK(LH)</sub>	Channel-to-Channel Skew (Note 4)				0.3	ns
t <sub>SK(PP)</sub>	Part-to-Part Skew (Note 5)				1.0	ns
f <sub>MAX</sub>	Maximum Frequency (Note 6)		200	275		MHz
t <sub>ZHD</sub>	Differential Output Enable Time from Z to HIGH			2.5	5.0	ns
t <sub>ZLD</sub>	Differential Output Enable Time from Z to LOW	$R_L = 100\Omega$ , $C_L = 10 pF$ ,		2.7	5.0	ns
t <sub>HZD</sub>	Differential Output Disable Time from HIGH to Z	See Figure 4 and Figure 5 (Note 7)		3.2	5.0	ns
t <sub>LZD</sub>	Differential Output Disable Time from LOW to Z			3.4	5.0	ns

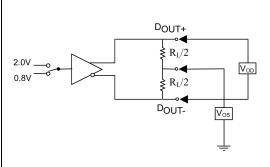
Note 3: All typical values are at  $T_A = 25^{\circ}C$  and with  $V_{CC} = 3.3V$ .

Note 4:  $t_{SK(LH)}$ ,  $t_{SK(HL)}$  is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction

Note 5:  $t_{SK(PP)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

Note 6:  $f_{MAX}$  Criteria: Input  $t_R = t_F < 1$  ns, 0V to 3V, 50% Duty Cycle; Output  $V_{OD} > 250$  mV, 45% to 55% Duty Cycle; all output channels switching in phase.

Note 7: Test Circuits in Figure 2 and Figure 4 are simplified representations of test fixture and DUT loading.



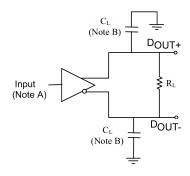
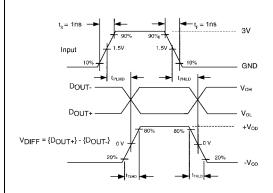
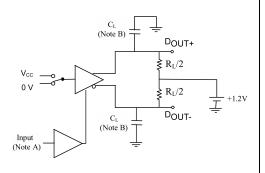


FIGURE 1. Differential Driver DC Test Circuit

Note A: All input pulses have frequency = 10 MHz,  $t_R$  or  $t_F$  = 1 ns Note B:  $C_L$  includes all fixture and instrumentation capacitances

FIGURE 2. Differential Driver Propagation Delay and Transition Time Test Circuit





Note B: All input pulses have the frequency = 10 MHz,  $t_{R}$  or  $t_{F}$  = 1 ns

Note A:  $C_L$  includes all fixture and instrumentation capacitances

FIGURE 4. Differential Driver Enable and Disable Test Circuit

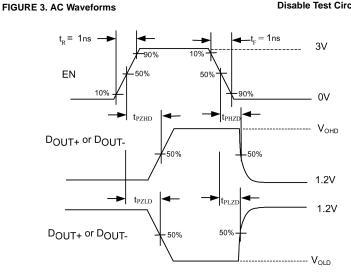
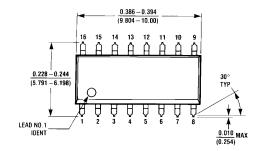
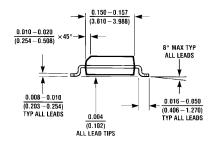
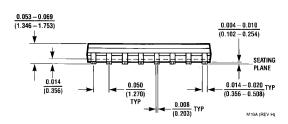


FIGURE 5. Enable and Disable AC Waveforms

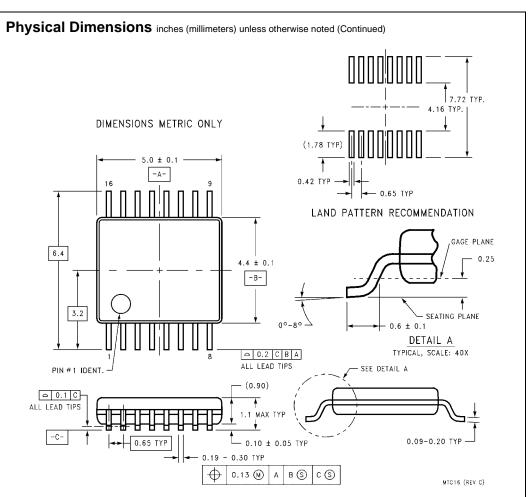
## Physical Dimensions inches (millimeters) unless otherwise noted







16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A



16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC16

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdt/Patent-Marking.pdf">www.onsemi.com/site/pdt/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

## **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

**ON Semiconductor:** 

FIN1031MTC FIN1031MTCX FIN1031MX FIN1031M



OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

#### Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный) Email: org@lifeelectronics.ru